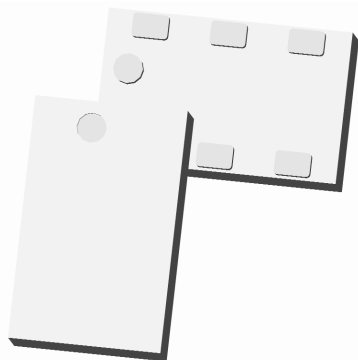


Xinger®

Ultra Low Profile 0805 Balun 50Ω to 200Ω Balanced



Description

The BD2425J50200AHF is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering the GSM frequencies. The BD2425J50200AHF is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2425J50200AHF has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2425J50200AHF is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

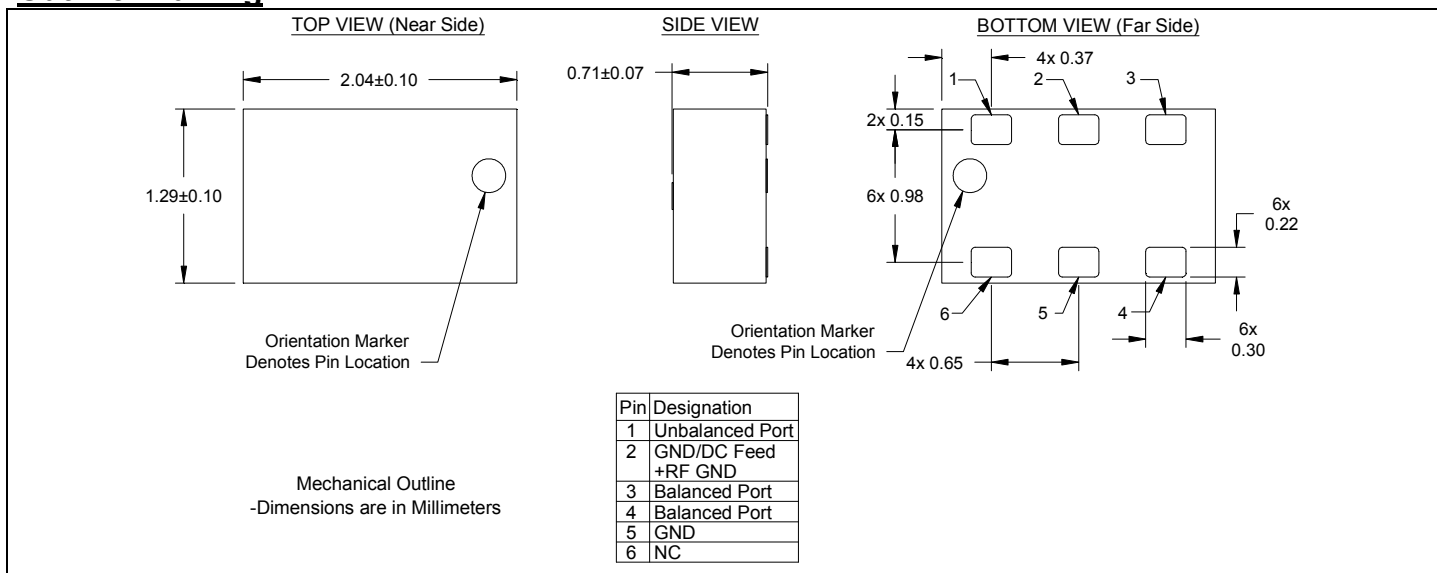
Features:

- 2400 – 2500 MHz
- 0.7mm Height Profile
- 50 Ohm to 2 x 100 Ohm
- 802.11 b+g +n Compliant
- Low Insertion Loss
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Non-conductive Surface
- RoHS Compliant

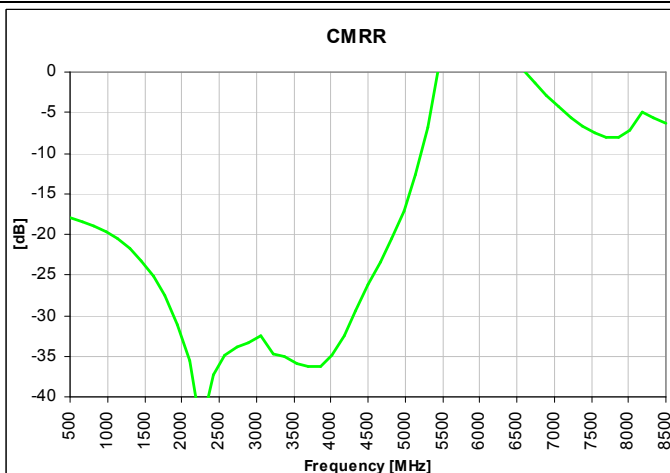
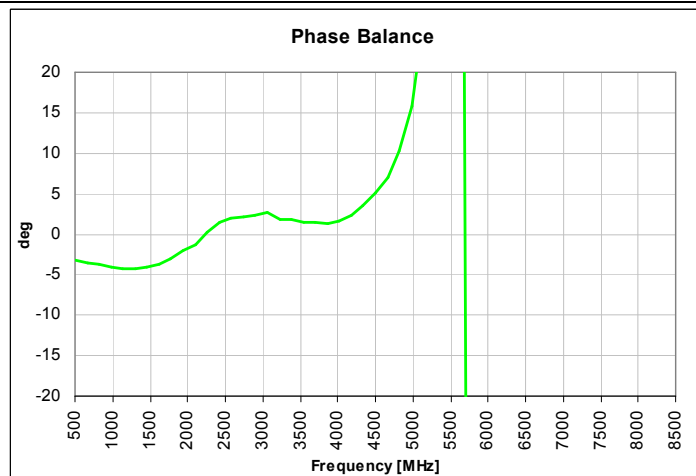
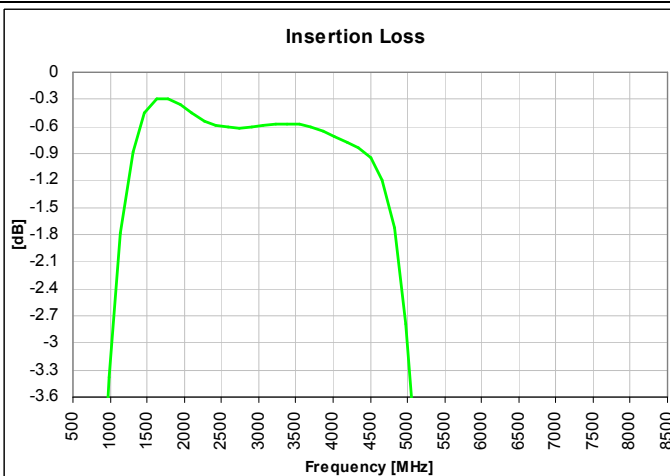
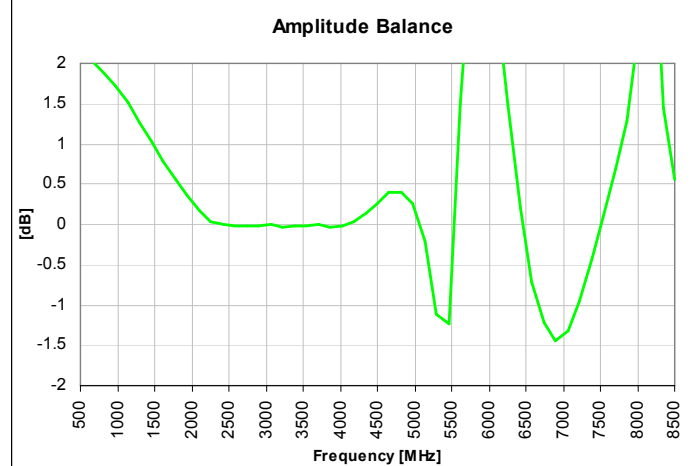
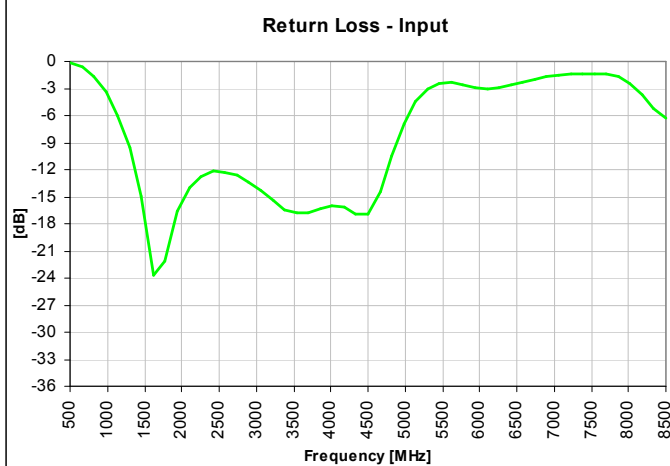
Parameter	ROOM (25°C)			Unit
	Min.	Typ.	Max	
Frequency	2400		2500	MHz
Unbalanced Port Impedance		50		Ω
Balanced Port Impedance		200		Ω
Return Loss	9.5	12.2		dB
Insertion Loss*		0.6	0.8	dB
Amplitude Balance		0.1	0.5	dB
Phase Balance		2	6	Degrees
CMRR		37		dB
Power Handling			2	Watts
Operating Temperature	-55		+85	°C

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

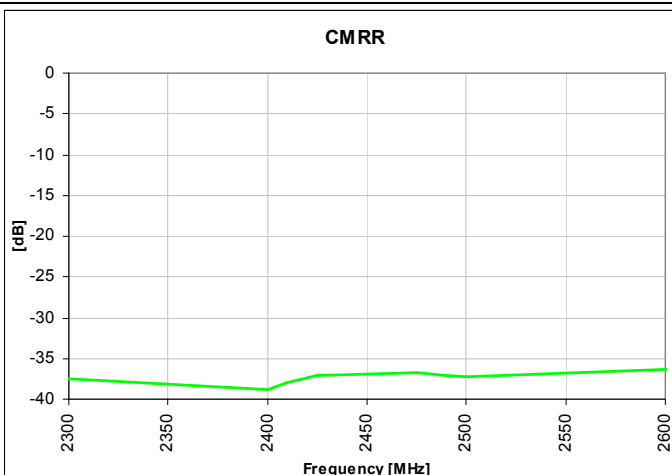
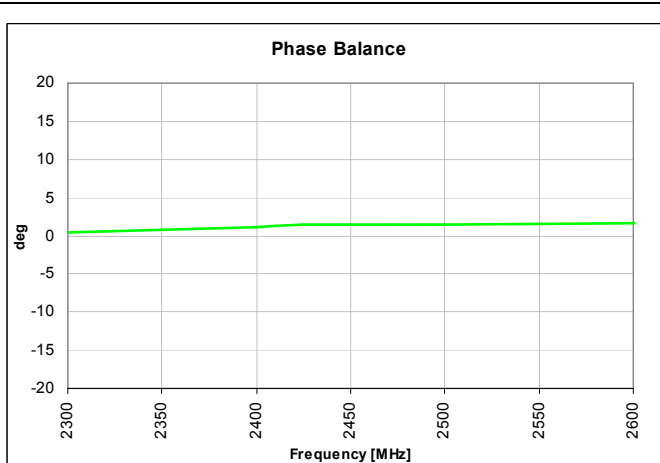
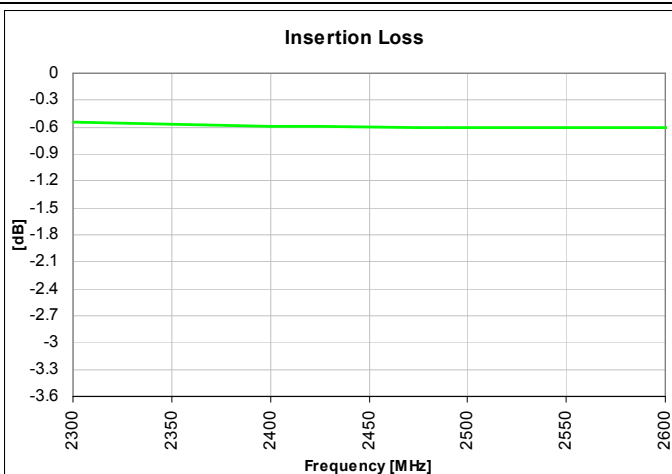
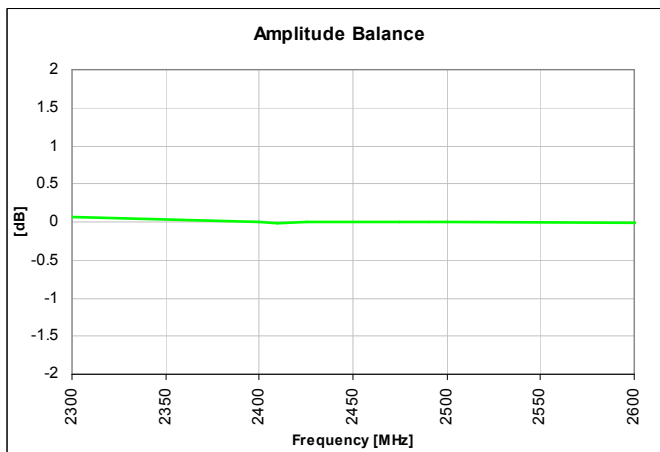
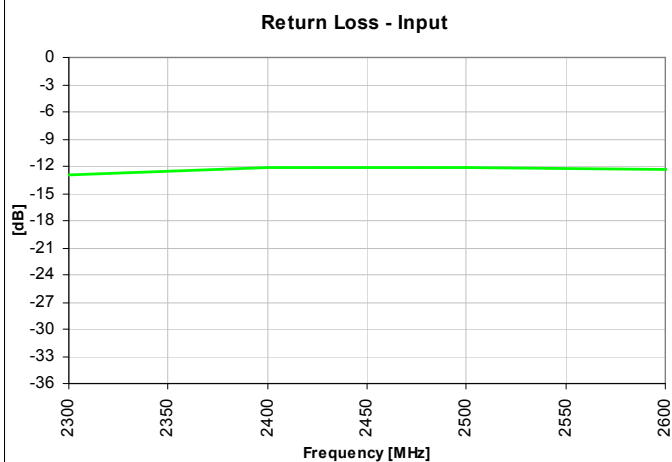
Outline Drawing



Typical Broadband Performance: 0 GHz. to 8.5 GHz.



Typical Performance: 2300 MHz. to 2600 MHz.



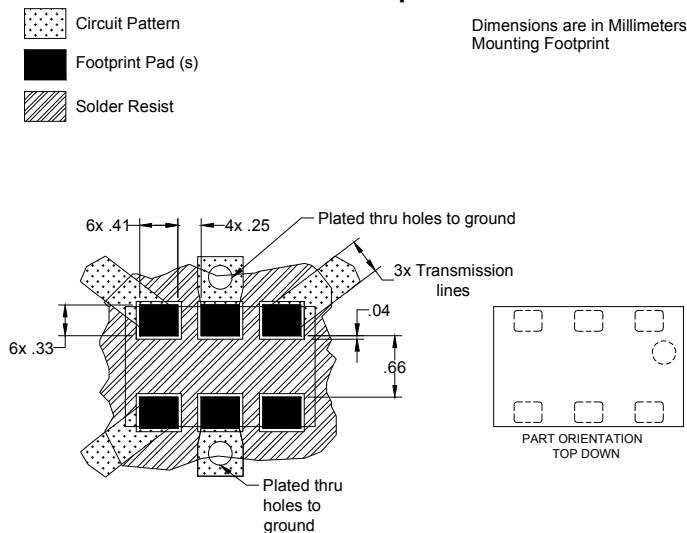
Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

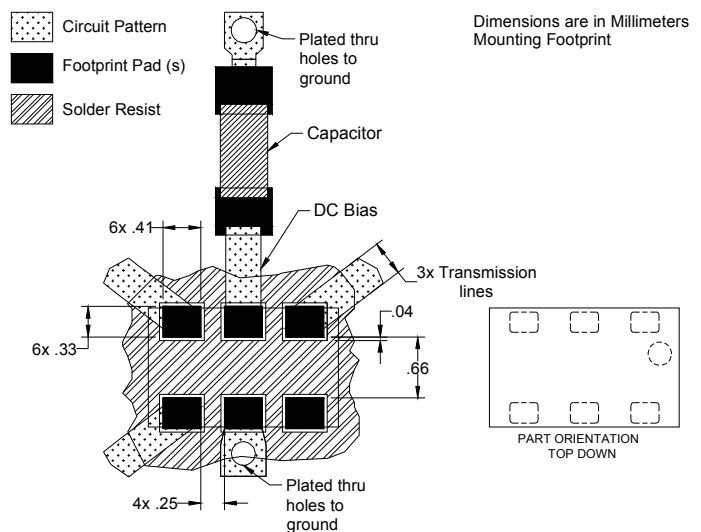
All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

No Bias Footprint



DC Bias Footprint



Packaging and Ordering Information

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.

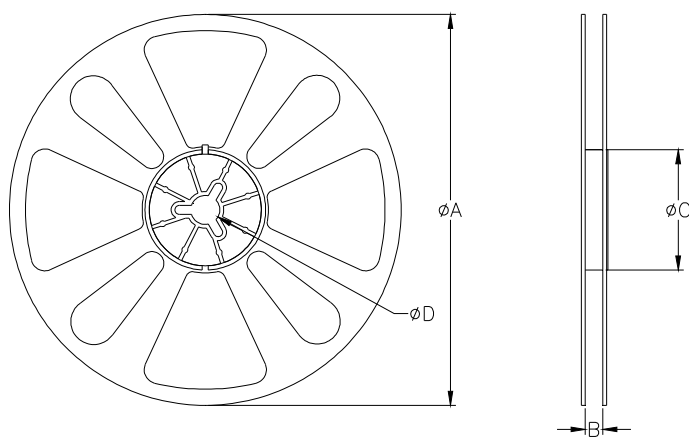
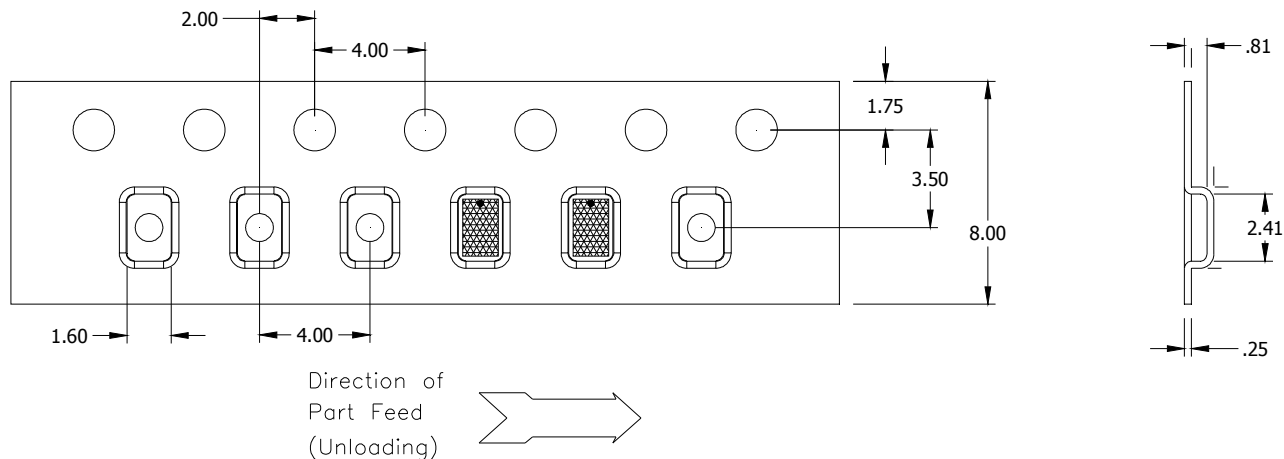


TABLE 1

QUANTITY/REEL	REEL DIMENSIONS mm	
4000	ϕA	177.80
	B	8.00
	ϕC	50.80
	ϕD	13.00